

(5.00 mm) .197"

50 Ω GANGED MICRO-MINI RF SYSTEMS

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?GRF1-J or www.samtec.com?GRF1-P

Shell Material:

Brass

Insulator Material:

PTFE

Contact Material:

BeCu

Pin Material:

Brass

Plating:

30 μ" (0.76 μm) Au
over 50 μ" (1.27 μm) Ni

Current Rating

(GRF1-J/GRF1-P):

Signals: 3.6 A per pin

(8 adjacent pins powered)

Grounds: 6.2 A per pin

(8 adjacent pins powered)

Operating Temp Range:

-40 °C to +90 °C

Impedance:

50 Ω

Dielectric

Withstanding Voltage:

500 Vrms, 50 Hz

Dielectric Working Voltage:

170 Vrms, 50 Hz

Frequency Range:

0-6 GHz

RoHS Compliant:

Yes

GRF1

J

P

NO. OF JACKS

PLATING

LEAD STYLE

TH1

INSERT OPTION

Mates with:

GRF1-P, GRF1-C,
GRF1H-C-02, -04,
-06, -08

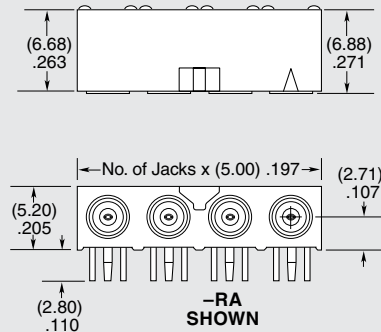
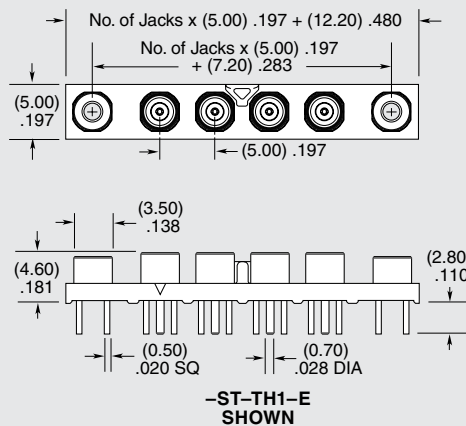
-E

= 30 μ" (0.76 μm)
Gold on Center
Conductor & Tail,
Gold Flash on
Shell and Tails

-ST
= Vertical-RA
= Right-angle

-E

= #1 - 64 Through-hole
Threaded Insert,
Mates with GRF1-C with
captive screw option



PROCESSING

Lead-Free Solderable:

Yes

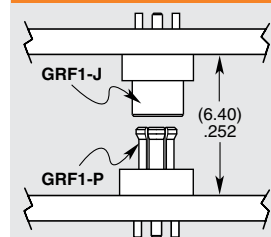
RECOGNITIONS

For complete scope of
recognitions see
www.samtec.com/quality



FILE NO. E111594

APPLICATION



OTHER SOLUTIONS

- Cable assembly
(see GRF1-C Series)

GRF1

P

P

NO. OF PLUGS

PLATING

ST

TH1

Mates with:

GRF1-J

-02, -04, -06, -08

-E

= 30 μ" (0.76 μm) Gold on Center Conductor & Tail,
Gold Flash on Shell and Tails

